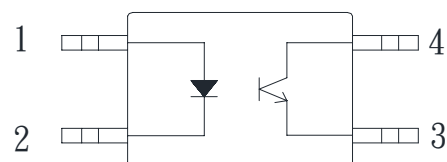


● Description

The KT1000 series consist of an infrared emitting diode, optically coupled to a phototransistor detector, and is incorporated in a 4 pin LSOP wide body package. It features a high current transfer ratio, low coupling capacitance and high isolation voltage.

● Schematic



1. Anode
2. Cathode
3. Emitter
4. Collector

● Features

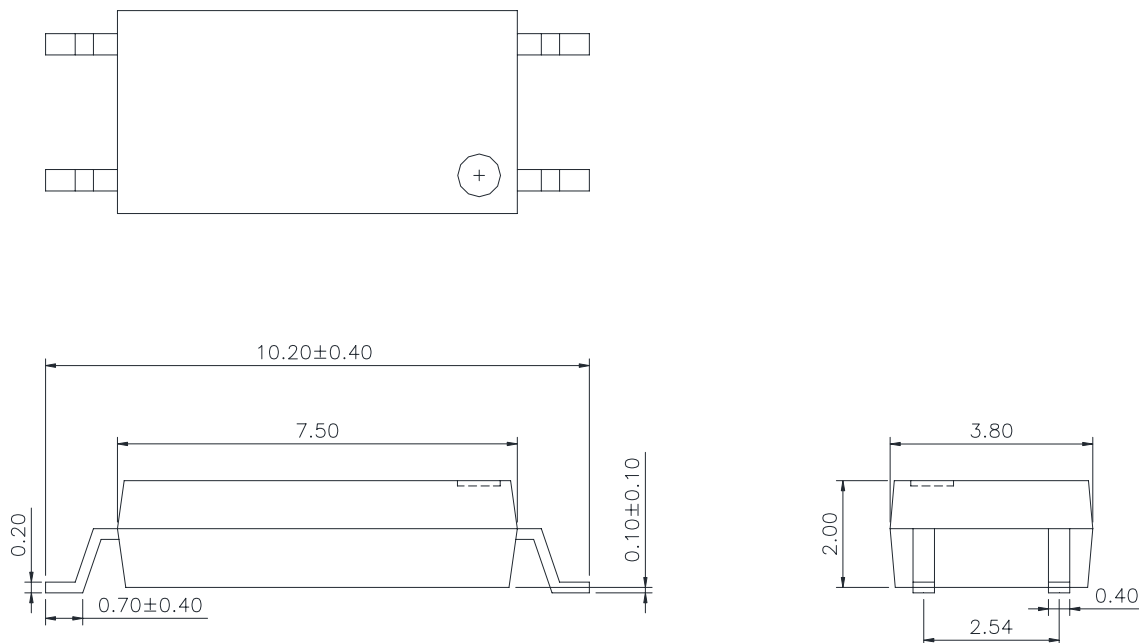
1. Halogen free
2. Pb free and RoHS compliant
3. High isolation voltage 5000Vrms
4. Opaque type, SMD low profile 4 lead package
5. Current transfer ratio
(CTR : Min.50% at $I_F=5mA$ $V_{CE}=5V$)
6. 8mm outer creepage distance
7. DC input with transistor output
8. MSL class 1
9. Agency Approvals:
 - UL Approved (No. E169586): UL1577
 - c-UL Approved (No. E169586)
 - VDE Approved (No. 40031267): DIN EN60747-5-5
 - FIMKO Approved: EN60065, EN60950, EN60335, EN60601
 - CQC Approved: GB8898-2011, GB4943.1-2011

● Applications

- Hybrid substrates that require high density mounting.
- Programmable controllers.
- Switch mode power supplies.
- Microprocessor system interface.

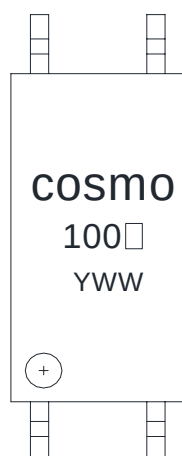
● Outside Dimension

Unit : mm



TOLERANCE : $\pm 0.2\text{mm}$

● Device Marking



Notes:

cosmo

100□

YWW

□: CTR rank

Y: Year code / WW: Week code

● Absolute Maximum Ratings

(Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	Peak forward current	I_{FP}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P_D	100	mW
Output	Collector-Emitter voltage	V_{CEO}	80	V
	Emitter-Collector voltage	V_{ECO}	7	V
	Collector current	I_C	50	mA
	Collector power dissipation	P_C	150	mW
Total power dissipation		P_{tot}	250	mW
Isolation voltage 1 minute		V_{iso}	5000	Vrms
Operating temperature		T_{opr}	-55 to +100	°C
Storage temperature		T_{stg}	-55 to +125	°C
Soldering temperature 10 second		T_{sol}	260	°C

● Electro-optical Characteristics

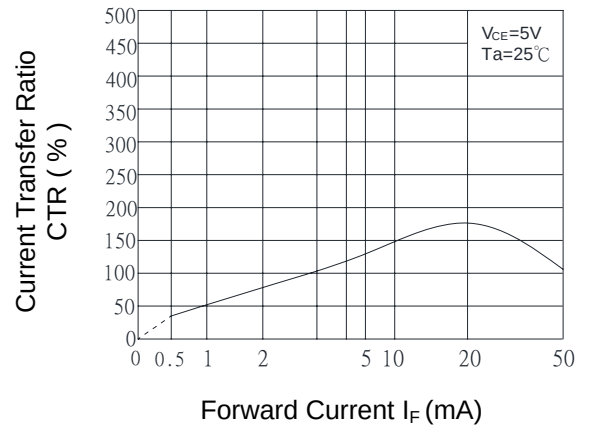
(Ta=25°C)

Parameter		Symbol	Conditions	Min.	Typ.	Max.	Unit
Input	Forward voltage	V_F	$I_F=20mA$	-	1.2	1.4	V
	Reverse current	I_R	$V_R=4V$	-	-	10	uA
	Terminal capacitance	C_t	$V=0, f=1KHz$	-	30	250	pF
Output	Collector dark current	I_{CEO}	$V_{CE}=20V, I_F=0$	-	-	0.1	uA
	Collector-Emitter breakdown voltage	BV_{CEO}	$I_C=0.1mA, I_F=0$	80	-	-	V
	Emitter-Collector breakdown voltage	BV_{ECO}	$I_E=100uA, I_F=0$	7	-	-	V
Transfer characteristics	Current transfer ratio	CTR	$I_F=5mA, V_{CE}=5V$	50	-	600	%
			$I_F=1mA, V_{CE}=5V$	15			
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F=10mA, I_C=1mA$	-	0.1	0.3	V
	Isolation resistance	R_{iso}	DC500V, 40 to 60%RH	5×10^{10}	10^{11}	-	Ω
	Floating capacitance	C_f	$V=0, f=1MHz$	-	0.6	1.0	pF
	Response time (Rise)	t_r	$V_{CC}=2V, I_C=2mA, R_L=100\Omega$	-	5	-	us
	Response time (Fall)	t_f		-	4	-	us

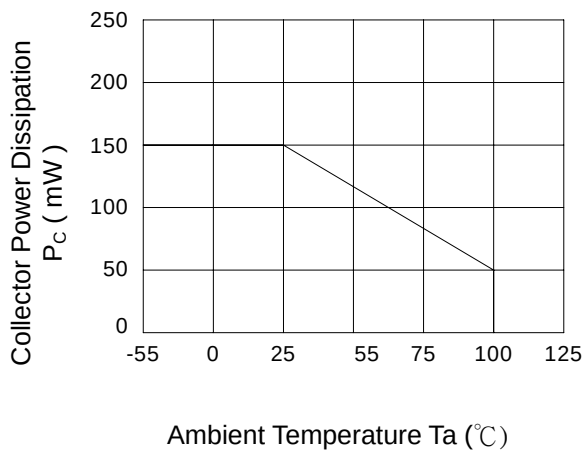
Classification table of current transfer ratio is shown below.

CTR Rank	CTR (%)
KT1005	50 TO 150
KT1006	100 TO 300
KT1007	80 TO 160
KT1008	130 TO 260
KT1009	200 TO 400
KT1000	50 TO 600

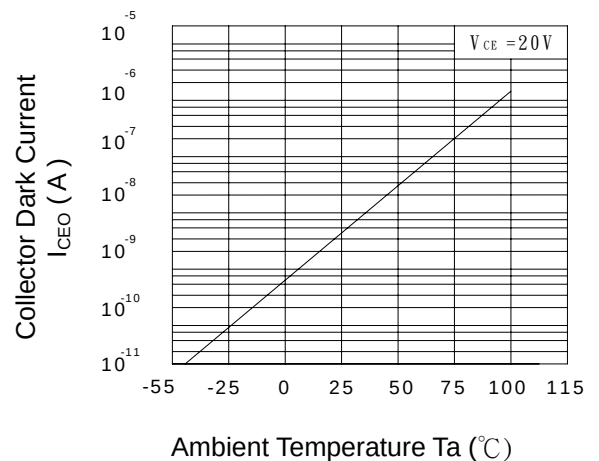
**Fig.1 Current Transfer Ratio
vs. Forward Current**



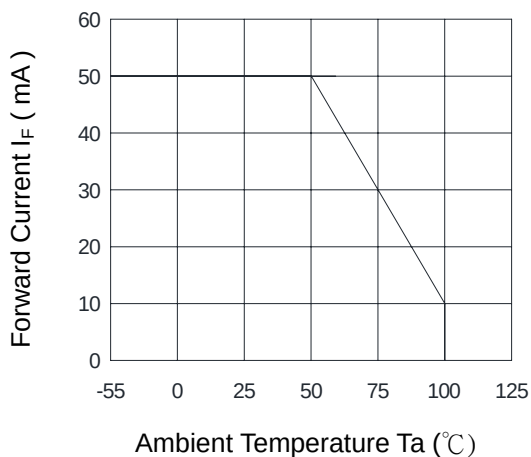
**Fig.2 Collector Power Dissipation
vs. Ambient Temperature**



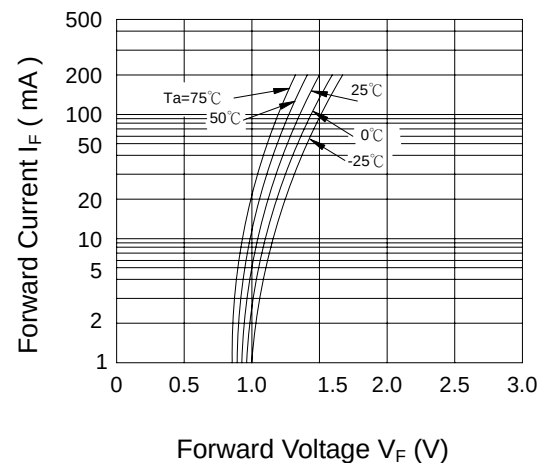
**Fig.3 Collector Dark Current
vs. Ambient Temperature**



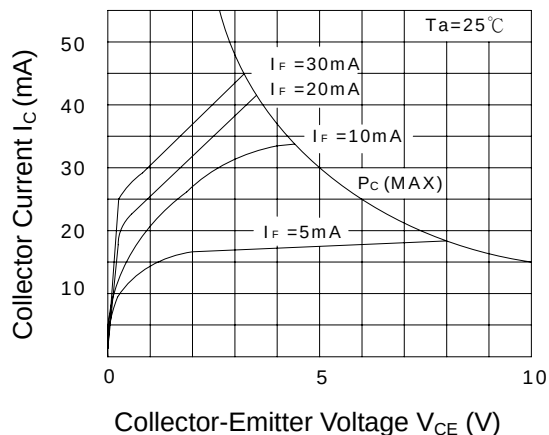
**Fig.4 Forward Current
vs. Ambient Temperature**



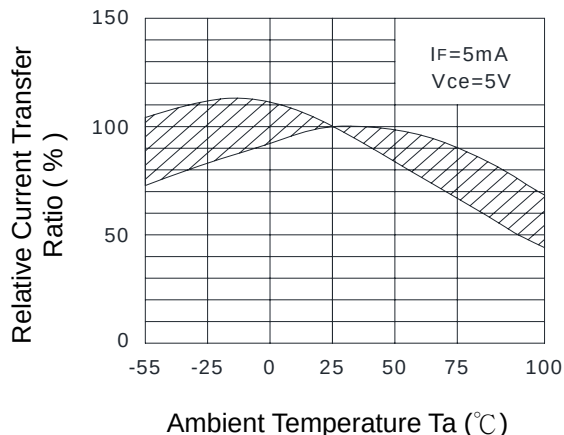
**Fig.5 Forward Current
vs. Forward Voltage**



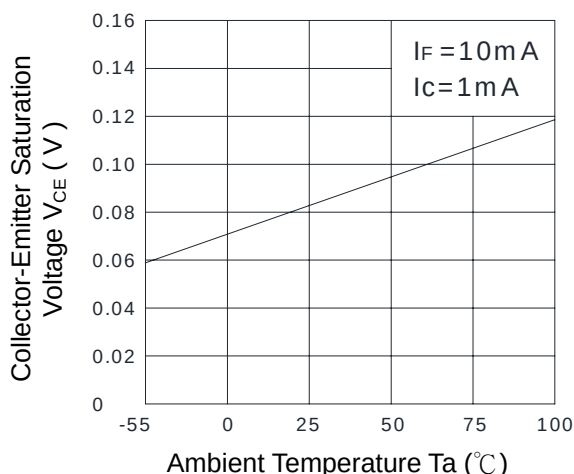
**Fig.6 Collector Current
vs. Collector-Emitter Voltage**



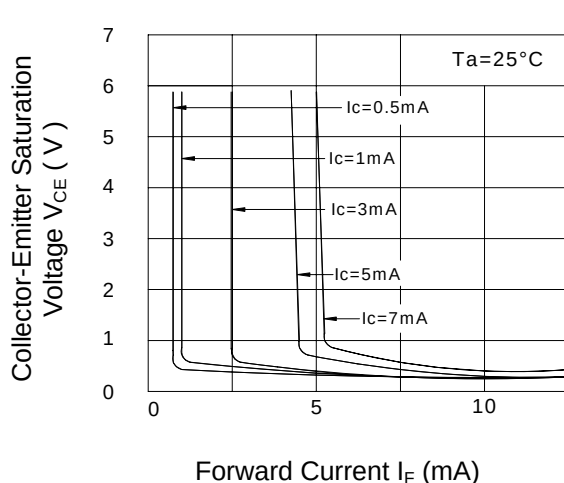
**Fig.7 Relative Current Transfer Ratio
vs. Ambient Temperature**



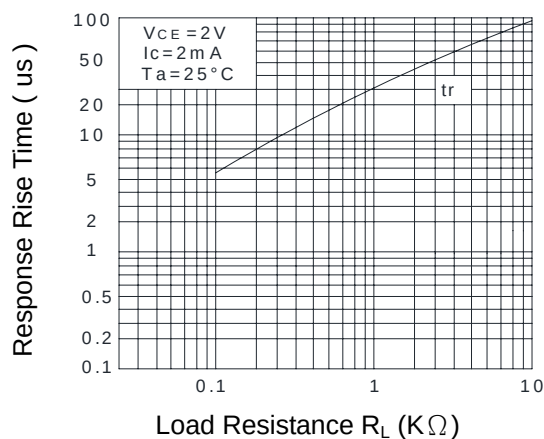
**Fig.8 Collector-Emitter Saturation Voltage
vs. Ambient Temperature**



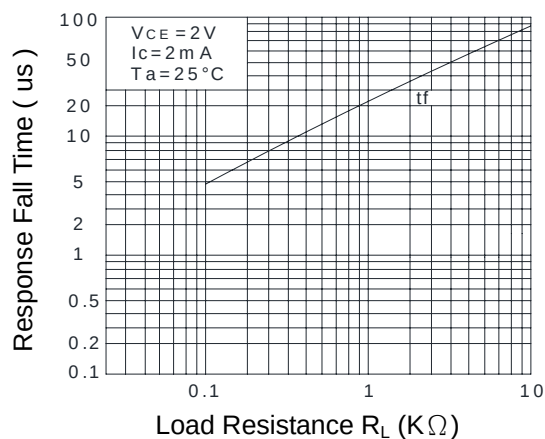
**Fig.9 Collector-Emitter Saturation
Voltage vs. Forward Current**



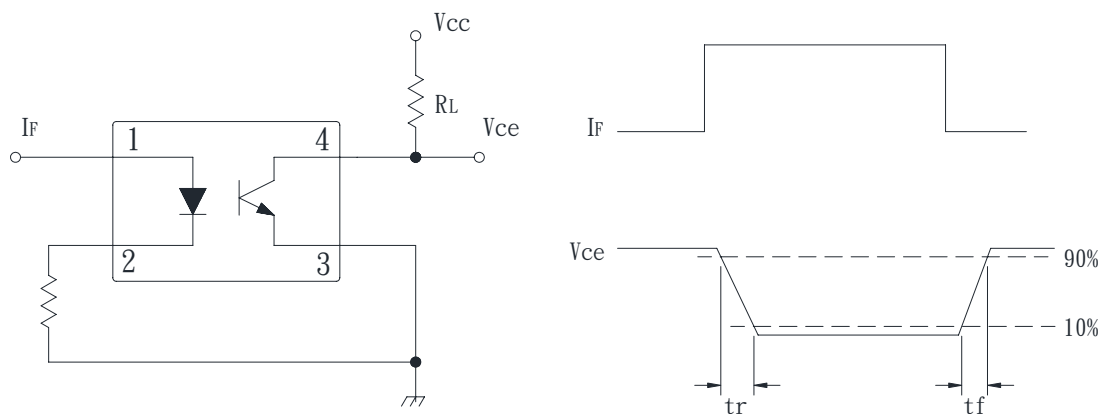
**Fig.10 Response Time (Rise)
vs. Load Resistance**



**Fig.11 Response Time (Fall)
vs. Load Resistance**



● Test Circuit for Response Time

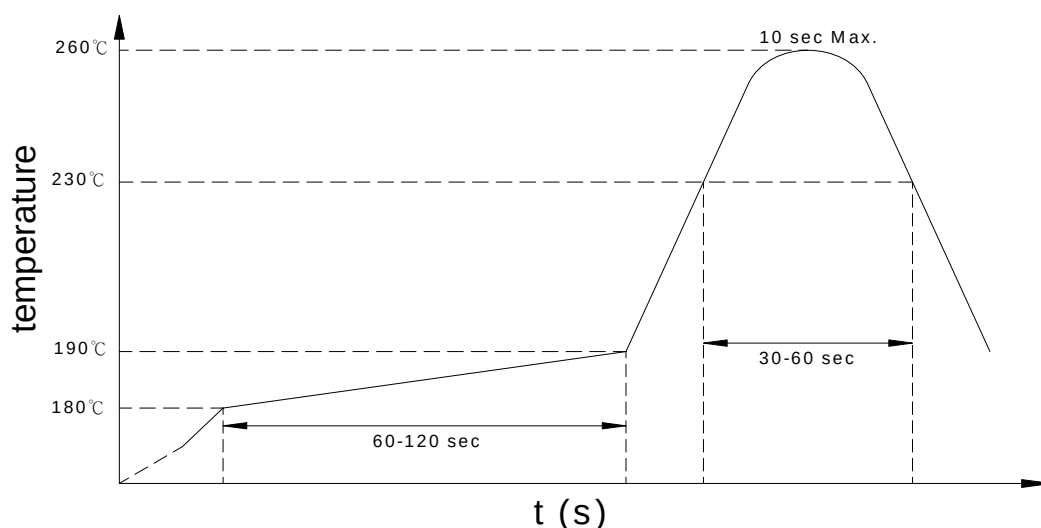


● Recommended Soldering Conditions

(a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature : 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Time(s) of reflow : Two
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions : 120°C or below (package surface temperature)
- Time(s) of reflow : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

● Numbering System

KT100 Y (Z)

Notes:

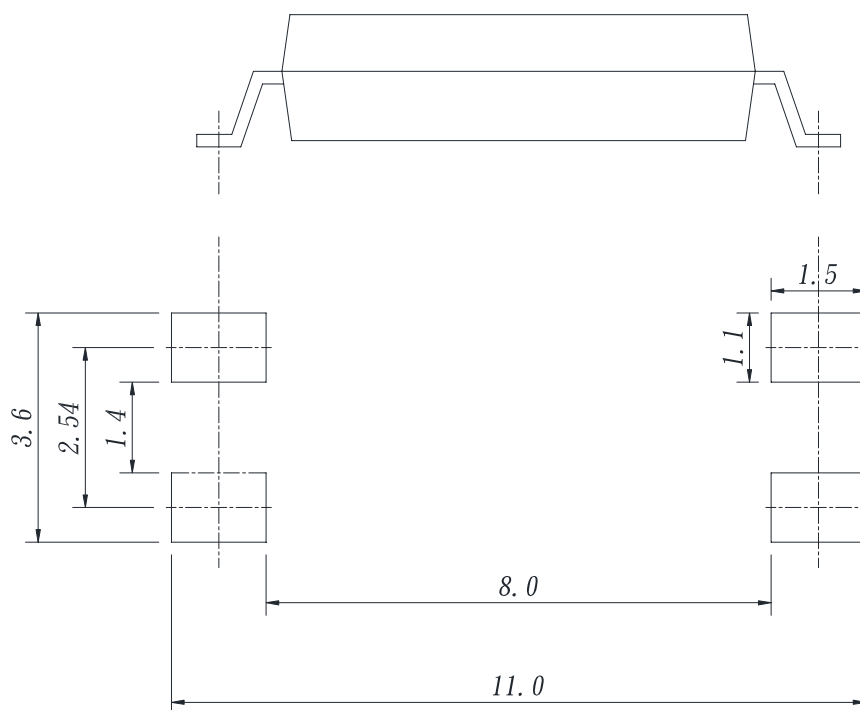
KT100 = Part No.

Y = CTR rank option (0、5 ~ 9)

Z = Tape and reel option (TLD、TRU)

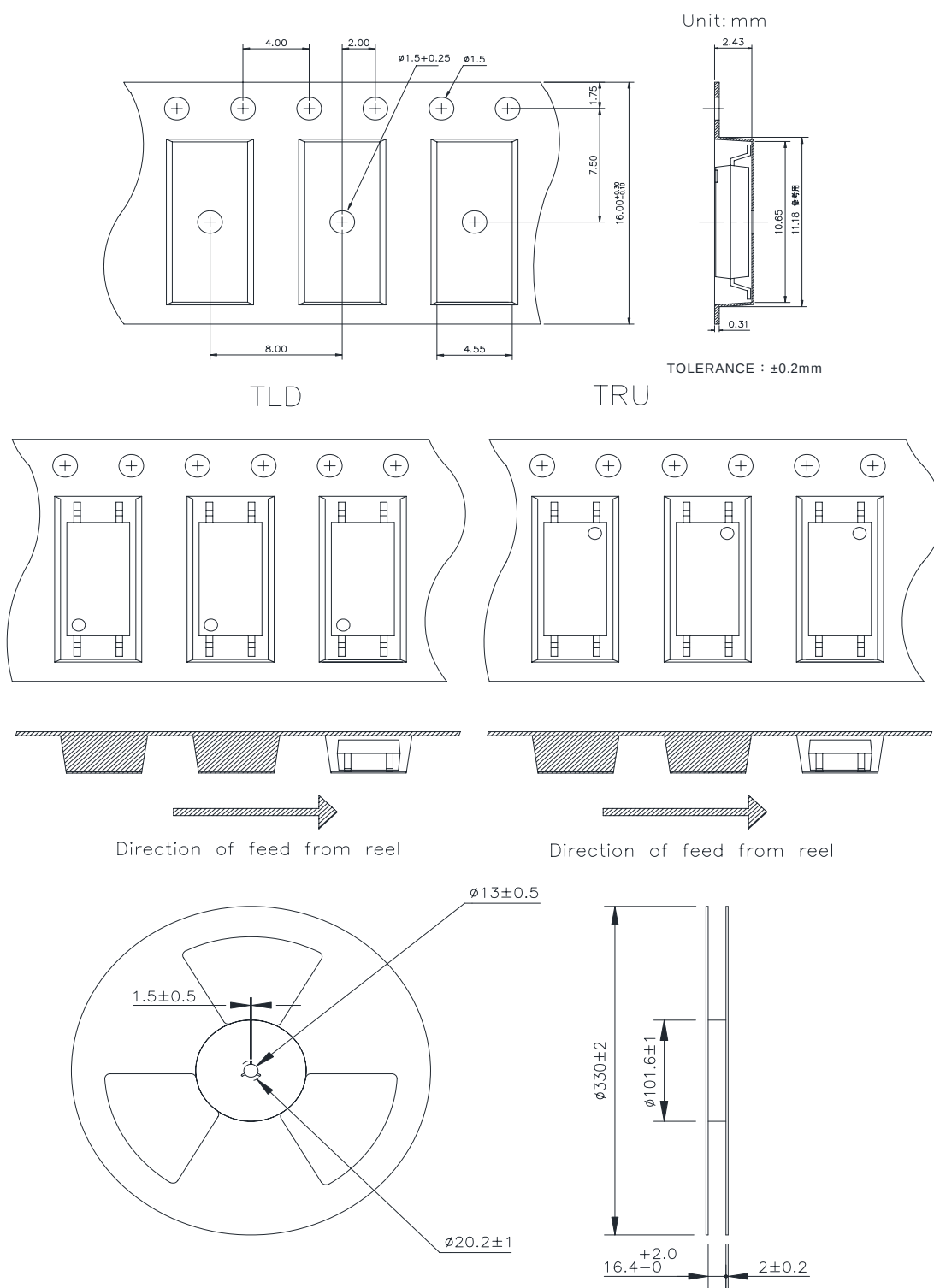
Option	Description	Packing quantity
TLD	TLD tape & reel option	3000 units per reel
TRU	TRU tape & reel option	3000 units per reel

● Recommended Pad Layout for Surface Mount Lead Form



Unit : mm

● 4-pin LSOP Carrier Tape & Reel



● Application Notice

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- h. Telecommunication

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- d. Nuclear power control
- e. Equipment used for automotive vehicles, trains, ships...etc.

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